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SUBMISSION TYPE	BMISSION TYPE:		Г	
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT	
CONVEYING PART				
Name			Execution Date	
Kenneth R Rhyner			06/10/2008	
Kevin Lyne			06/24/2008	
David G Wontor			06/14/2008	
Peter R Harper			06/10/2008	
RECEIVING PARTY	Y DATA			
Name:	Texas Instru	Texas Instruments Incorporated		
Street Address:	7839 Church	7839 Churchill Way		
Internal Address:	MS 3999			
City:	Dallas			
State/Country:	TEXAS			
Postal Code:	75251			
Property Type		Number		
Application Number:		12124305		
CORRESPONDEN	CE DATA			
Fax Number:	(972)9 ⁻	7-4418		
-		S Mail when the fax attempt is	unsuccessful.	
Phone: 972-917-4371				
Email: uspto@ti.com				
Correspondent Name: Texas Instruments Incorporated Address Line 1: P O BOX 655474				
Address Line 1:P O BOX 655474Address Line 2:MS 3999				
Address Line 4: Dallas, TEXAS 75265				
ATTORNEY DOCKET NUMBER:		TI-64664		
NAME OF SUBMITTER:		Yingsheng Tung		
		I	PATENT	
500580614			REEL: 021171 FRAME: 0282	

Total Attachments: 4 source=TI-64664_EXECUTED_ASSIGNMENT#page1.tif source=TI-64664_EXECUTED_ASSIGNMENT#page2.tif source=TI-64664_EXECUTED_ASSIGNMENT#page3.tif source=TI-64664_EXECUTED_ASSIGNMENT#page4.tif

Attorney Docket No. TI-64664

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, M/S 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting thereform, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, tille and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	BGA PACKAGE WITH TRACES FOR PLATING PADS UNDER THE CHIP
SIGNATURE OF INVENTOR AND NAME	Kenneth R. Rhyner Kenneth Q Chyner
DATE	6-10-2008
RESIDENCE (CITY AND STATE)	1895 Creekside Dr. Rockwall, TX 75087
DATE APPLICATION EXECUTED	

PATENT REEL: 021171 FRAME: 0284

TI-64664 - Assignment

TITLE OF INVENTION	BGA PACKAGE WITH TRACES FOR PLATING PADS UNDER THE CHIP
SIGNATURE OF INVENTOR AND NAME	Kevin Lyne
DATE	6-24-08
RESIDENCE (CITY AND STATE)	90 Elisabeth Way Fairview,TX 75069
DATE APPLICATION EXECUTED	

TITLE OF INVENTION	BGA PACKAGE WITH TRACES FOR PLATING PADS UNDER THE CHI
SIGNATURE OF INVENTOR AND NAME	David G. Wontor
DATE	Jove 14 2008
RESIDENCE (CITY AND STATE)	5270 San Viciente Terrace Dublin, CA 94568
DATE APPLICATION EXECUTED	Jon 14 2000

TI-64664 - Assignment

TITLE OF INVENTION	BGA PACKAGE WITH TRACES FOR PLATING PADS UNDER THE CHIP
SIGNATURE OF INVENTOR AND NAME	Peter R. Harper
DATE	6/10/2002
RESIDENCE (CITY AND STATE)	1615 Holyoak Lane Lucas, TX 75002
DATE APPLICATION EXECUTED	

After recording, return Assignment to:

Wade James Brady III Texas instruments Incorporated PO Box 655474, M/S 3999 Dallas, TX, 75265